

BC817-16W / -25W / -40W

NPN SURFACE MOUNT SMALL SIGNAL TRANSISTOR

Features

Ideally Suited for Automatic Insertion

Epitaxial Planar Die Construction

For Switching, AF Driver and Amplifier Applications

Complementary PNP Types Available (BC807-xxW)

Lead Free By Design/RoHS Compliant (Note 1)

"Green" Device (Note 2)

Mechanical Data

Case: SOT-323

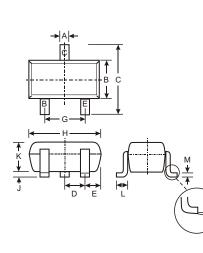
Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

Terminals: Finish – Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208 Pin Connections: See Diagram

Marking:	P/N	Marking		
	BC817-16W	K6A		
	BC817-25W	K6B		
	BC817-40W	K6C		

Ordering & Date Code Information: See Page 3 Approximate Weight: 0.006 grams



SOT-323								
Dim Min Max								
Α	0.25	0.40						
В	1.15	1.35						
С	2.00 2.20							
D	0.65 Nominal							
E	0.30	0.40						
G	1.20	1.40						
н	1.80	2.20						
J	0.0	0.10						
К	0.90 1.00							
L	0.25	0.40						
М	0.10	0.18						
	0	8						
All Dimensions in mm								

Maximum Ratings	$@T_A = 25^{\circ}C$ unless otherwise specified					
r						

Characteristic	Symbol	Value	Unit	
Collector-Emitter Voltage	V _{CEO}	45	V	
Emitter-Base Voltage	V _{EBO}	5.0	V	
Collector Current	Ι _C	500	mA	
Peak Collector Current	I _{CM}	1000	mA	
Peak Emitter Current	I _{EM}	1000	mA	
Power Dissipation at T_{SB} = 50°C (Note 3)	Pd	200	mW	
Thermal Resistance, Junction to Ambient Air (Note 3)	R JA	625	°C/W	
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	۵°C	

Electrical Characteristics @T_A = 25°C unless otherwise specified

Character	ristic (Note 4)	Symbol	Min	Max	Unit	Test Condition
DC Current Gain	C Current Gain Current Gain Group -1 -2 -4 Current Gain Group -1 -2 -4		100 160 250 60 100 170	250 400 600 —	_	V_{CE} = 1.0V, I _C = 100mA V_{CE} = 1.0V, I _C = 300mA
Collector-Emitter Saturation Voltage		V _{CE(SAT)}	_	0.7	V	$I_{\rm C} = 500 {\rm mA}, I_{\rm B} = 50 {\rm mA}$
Base-Emitter Voltage	V_{BE}	_	1.2	V	$V_{CE} = 1.0V, I_{C} = 300mA$	
Collector-Emitter Cutoff Current		ICES	—	100 5.0	nA μA	$\begin{array}{l} V_{CE}=45V\\ V_{CE}=25V,T_{j}=150^{\circ}C \end{array}$
Emitter-Base Cutoff Current		I _{EBO}	—	100	nA	V _{EB} = 4.0V
Gain Bandwidth Product		f⊤	100	_	MHz	$\label{eq:VCE} \begin{array}{l} V_{CE} = 5.0V, \ I_C = 10mA, \\ f = 50MHz \end{array}$
Collector-Base Capacitance		C _{CBO}	—	12	pF	V _{CB} = 10V, f = 1.0MHz

Notes: 1. No purposefully added lead.

2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

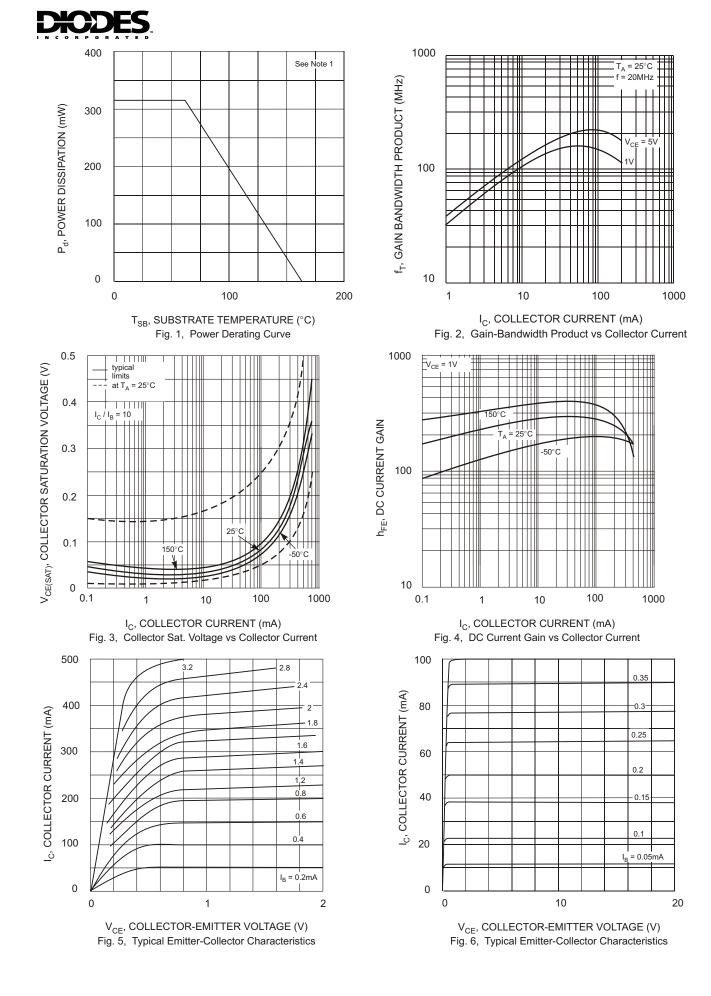
3. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001,

which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

4. Short duration pulse test used to minimize self-heating effect.

DS30575 Rev. 4 - 2

BC817-16W/-25W/-40W Diodes Incorporated



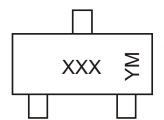


Ordering Information (Note 5)

Device*	Packaging	Shipping			
BC817-xxW-7	SOT-323	3000/Tape & Reel			

Notes: 5. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. * xx = gain group, e.g. BC817-16W-7.

Marking Information



 $\begin{array}{l} XXX = \mbox{Product Type Marking Code (See Page 1), e.g. K6A = BC817-16} \\ YM = \mbox{Date Code Marking} \\ Y = \mbox{Year ex: } S = 2005 \\ M = \mbox{Month ex: } 9 = \mbox{September} \end{array}$

Date Code Key

Year	2004	20	005	2006	200)7	2008	200	9	2010	201	1	2012
Code	R		s	Т	U		V		W X		Y		Z
Mon	th	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Cod	le	1	2	3	4	5	6	7	8	9	0	N	D

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